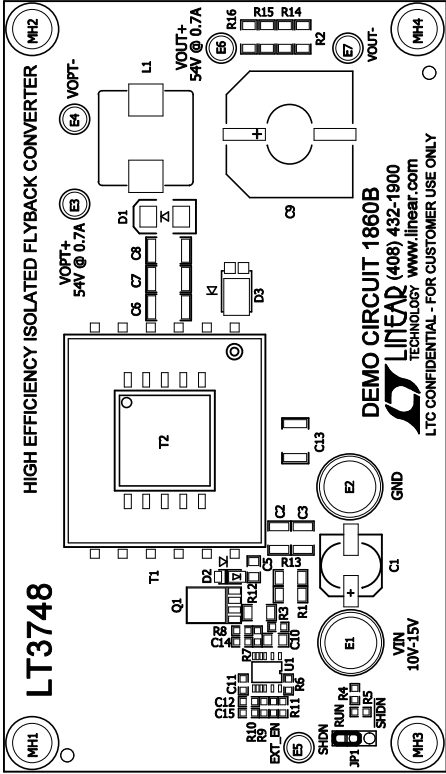


REVISION HISTORY			
ECO	REV	DESCRIPTION	DATE
-	1	PRODUCTION	10-01-12

NOTES: UNLESS OTHERWISE SPECIFIED

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-810.
2. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD. MAXIMUM SOLDER TEMPERATURE IS 240 DEGREES CELSIUS.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS. LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. INSTALL SHUNTS AS SHOWN ON ASSY DRAWING.
5. DEPANLIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
6. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP TO ANY BOARD.



APPROVALS		LTC CONFIDENTIAL - FOR CUSTOMER USE ONLY	
PCB DES.	RB	TITLE: TOP ASSEMBLY DRAWING HIGH EFFICIENCY ISOLATED FLYBACK CONVERTER	
APP ENG.	ZY		
		SIZE	IC NO. LT3748EMS
		N/A	REV. 1
		FILENAME: 1860B-Rev1.PCB	SHT 1 OF 1